

# IRG4PC50FDPbF

INSULATED GATE BIPOLAR TRANSISTOR WITH  
ULTRAFAST SOFT RECOVERY DIODE

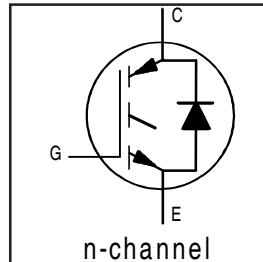
Fast CoPack IGBT

## Features

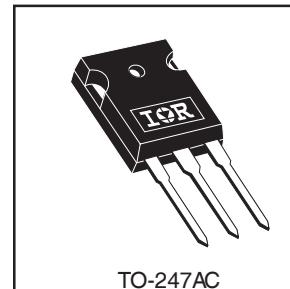
- Fast: Optimized for medium operating frequencies ( 1-5 kHz in hard switching, >20 kHz in resonant mode).
- Generation 4 IGBT design provides tighter parameter distribution and higher efficiency than Generation 3
- IGBT co-packaged with HEXFRED™ ultrafast, ultra-soft-recovery anti-parallel diodes for use in bridge configurations
- Industry standard TO-247AC package
- Lead-Free

## Benefits

- Generation -4 IGBT's offer highest efficiencies available
- IGBT's optimized for specific application conditions
- HEXFRED diodes optimized for performance with IGBT's . Minimized recovery characteristics require less/no snubbing
- Designed to be a "drop-in" replacement for equivalent industry-standard Generation 3 IR IGBT's



$V_{CES} = 600V$   
 $V_{CE(on)} \text{ typ.} = 1.45V$   
@  $V_{GE} = 15V, I_C = 39A$



## Absolute Maximum Ratings

|                           | Parameter  | Max.                              | Units      |
|---------------------------|--|-----------------------------------|------------|
| $V_{CES}$                 | Collector-to-Emitter Voltage                     | 600                               | V          |
| $I_C @ T_C = 25^\circ C$  | Continuous Collector Current                     | 70                                | A          |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current                     | 39                                |            |
| $I_{CM}$                  | Pulsed Collector Current ①                       | 280                               |            |
| $I_{LM}$                  | Clamped Inductive Load Current ②                 | 280                               |            |
| $I_F @ T_C = 100^\circ C$ | Diode Continuous Forward Current                 | 25                                |            |
| $I_{FM}$                  | Diode Maximum Forward Current                    | 280                               |            |
| $V_{GE}$                  | Gate-to-Emitter Voltage                          | $\pm 20$                          | V          |
| $P_D @ T_C = 25^\circ C$  | Maximum Power Dissipation                        | 200                               | W          |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation                        | 78                                |            |
| $T_J$<br>$T_{STG}$        | Operating Junction and Storage Temperature Range | -55 to +150                       | $^\circ C$ |
|                           | Soldering Temperature, for 10 sec.               | 300 (0.063 in. (1.6mm) from case) |            |
|                           | Mounting Torque, 6-32 or M3 Screw.               | 10 lbf•in (1.1 N•m)               |            |

## Thermal Resistance

|           | Parameter                                 | Min.  | Typ.     | Max.  | Units        |
|-----------|---|-------|----------|-------|--------------|
| $R_{0JC}$ | Junction-to-Case - IGBT                   | ----- | -----    | 0.64  | $^\circ C/W$ |
| $R_{0JC}$ | Junction-to-Case - Diode                  | ----- | -----    | 0.83  |              |
| $R_{0CS}$ | Case-to-Sink, flat, greased surface       | ----- | 0.24     | ----- |              |
| $R_{0JA}$ | Junction-to-Ambient, typical socket mount | ----- | -----    | 40    |              |
| Wt        | Weight                                    | ----- | 6 (0.21) | ----- | g (oz)       |

# IRG4PC50FDPbF

International  
Rectifier

## Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

|   | Parameter   | Min. | Typ. | Max.      | Units                | Conditions  |
|---|---|------|------|-----------|----------------------|---|
| $V_{(\text{BR})\text{CES}}$                   | Collector-to-Emitter Breakdown Voltage <sup>③</sup> | 600  | ---- | ----      | V                    | $V_{\text{GE}} = 0\text{V}$ , $I_C = 250\mu\text{A}$                                    |
| $\Delta V_{(\text{BR})\text{CES}/\Delta T_J}$ | Temperature Coeff. of Breakdown Voltage             | ---- | 0.62 | ----      | V/ $^\circ\text{C}$  | $V_{\text{GE}} = 0\text{V}$ , $I_C = 1.0\text{mA}$                                      |
| $V_{\text{CE}(\text{on})}$                    | Collector-to-Emitter Saturation Voltage             | ---- | 1.45 | 1.6       | V                    | $I_C = 39\text{A}$ $V_{\text{GE}} = 15\text{V}$   |
|   |   | ---- | 1.79 | ----      |                      | $I_C = 70\text{A}$ See Fig. 2, 5  |
|   |   | ---- | 1.53 | ----      |                      | $I_C = 39\text{A}$ , $T_J = 150^\circ\text{C}$  |
| $V_{\text{GE}(\text{th})}$                    | Gate Threshold Voltage                              | 3.0  | ---- | 6.0       |                      | $V_{\text{CE}} = V_{\text{GE}}$ , $I_C = 250\mu\text{A}$                                |
| $\Delta V_{\text{GE}(\text{th})/\Delta T_J}$  | Temperature Coeff. of Threshold Voltage             | ---- | -14  | ----      | mV/ $^\circ\text{C}$ | $V_{\text{CE}} = V_{\text{GE}}$ , $I_C = 250\mu\text{A}$                                |
| $g_{\text{fe}}$                               | Forward Transconductance ④                          | 21   | 30   | ----      | S                    | $V_{\text{CE}} = 100\text{V}$ , $I_C = 39\text{A}$                                      |
| $I_{\text{CES}}$                              | Zero Gate Voltage Collector Current                 | ---- | ---- | 250       | $\mu\text{A}$        | $V_{\text{GE}} = 0\text{V}$ , $V_{\text{CE}} = 600\text{V}$                             |
|   |   | ---- | ---- | 6500      |                      | $V_{\text{GE}} = 0\text{V}$ , $V_{\text{CE}} = 600\text{V}$ , $T_J = 150^\circ\text{C}$ |
| $V_{\text{FM}}$                               | Diode Forward Voltage Drop                          | ---- | 1.3  | 1.7       | V                    | $I_C = 25\text{A}$ See Fig. 13  |
|   |   | ---- | 1.2  | 1.5       |                      | $I_C = 25\text{A}$ , $T_J = 150^\circ\text{C}$  |
| $I_{\text{GES}}$                              | Gate-to-Emitter Leakage Current                     | ---- | ---- | $\pm 100$ | nA                   | $V_{\text{GE}} = \pm 20\text{V}$  |

## Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

|                                 | Parameter  | Min. | Typ. | Max. | Units            | Conditions   |
|---------------------------------|--|------|------|------|------------------|--|
| $Q_g$                           | Total Gate Charge (turn-on)                      | ---- | 190  | 290  | nC               | $I_C = 39\text{A}$   |
| $Q_{\text{ge}}$                 | Gate - Emitter Charge (turn-on)                  | ---- | 28   | 42   |                  | $V_{\text{CC}} = 400\text{V}$ See Fig. 8   |
| $Q_{\text{gc}}$                 | Gate - Collector Charge (turn-on)                | ---- | 65   | 97   |                  | $V_{\text{GE}} = 15\text{V}$   |
| $t_{\text{d}(\text{on})}$       | Turn-On Delay Time                               | ---- | 55   | ---- | ns               | $T_J = 25^\circ\text{C}$   |
| $t_r$                           | Rise Time  | ---- | 25   | ---- |                  | $I_C = 39\text{A}$ , $V_{\text{CC}} = 480\text{V}$                                 |
| $t_{\text{d}(\text{off})}$      | Turn-Off Delay Time                              | ---- | 240  | 360  |                  | $V_{\text{GE}} = 15\text{V}$ , $R_G = 5.0\Omega$                                   |
| $t_f$                           | Fall Time  | ---- | 140  | 210  |                  | Energy losses include "tail" and diode reverse recovery.<br>See Fig. 9, 10, 11, 18 |
| $E_{\text{on}}$                 | Turn-On Switching Loss                           | ---- | 1.5  | ---- | mJ               |  |
| $E_{\text{off}}$                | Turn-Off Switching Loss                          | ---- | 2.4  | ---- |                  |  |
| $E_{\text{ts}}$                 | Total Switching Loss                             | ---- | 3.9  | 5.0  |                  |  |
| $t_{\text{d}(\text{on})}$       | Turn-On Delay Time                               | ---- | 59   | ---- | ns               | $T_J = 150^\circ\text{C}$ , See Fig. 9, 10, 11, 18                                 |
| $t_r$                           | Rise Time  | ---- | 27   | ---- |                  | $I_C = 39\text{A}$ , $V_{\text{CC}} = 480\text{V}$                                 |
| $t_{\text{d}(\text{off})}$      | Turn-Off Delay Time                              | ---- | 400  | ---- |                  | $V_{\text{GE}} = 15\text{V}$ , $R_G = 5.0\Omega$                                   |
| $t_f$                           | Fall Time  | ---- | 260  | ---- |                  | Energy losses include "tail" and diode reverse recovery.                           |
| $E_{\text{ts}}$                 | Total Switching Loss                             | ---- | 6.5  | ---- | mJ               |  |
| $L_E$                           | Internal Emitter Inductance                      | ---- | 13   | ---- | nH               | Measured 5mm from package  |
| $C_{\text{ies}}$                | Input Capacitance                                | ---- | 4100 | ---- | pF               | $V_{\text{GE}} = 0\text{V}$  |
| $C_{\text{oes}}$                | Output Capacitance                               | ---- | 250  | ---- |                  | $V_{\text{CC}} = 30\text{V}$ See Fig. 7  |
| $C_{\text{res}}$                | Reverse Transfer Capacitance                     | ---- | 49   | ---- |                  | $f = 1.0\text{MHz}$  |
| $t_{\text{rr}}$                 | Diode Reverse Recovery Time                      | ---- | 50   | 75   | ns               | $T_J = 25^\circ\text{C}$ See Fig.  |
|                                 |  | ---- | 105  | 160  |                  | $T_J = 125^\circ\text{C}$ 14   |
| $I_{\text{rr}}$                 | Diode Peak Reverse Recovery Current              | ---- | 4.5  | 10   | A                | $T_J = 25^\circ\text{C}$ See Fig.  |
|                                 |  | ---- | 8.0  | 15   |                  | $T_J = 125^\circ\text{C}$ 15   |
| $Q_{\text{rr}}$                 | Diode Reverse Recovery Charge                    | ---- | 112  | 375  | nC               | $T_J = 25^\circ\text{C}$ See Fig.  |
|                                 |  | ---- | 420  | 1200 |                  | $T_J = 125^\circ\text{C}$ 16   |
| $\frac{di_{(\text{rec})M}}{dt}$ | Diode Peak Rate of Fall of Recovery During $t_b$ | ---- | 250  | ---- | A/ $\mu\text{s}$ | $T_J = 25^\circ\text{C}$ See Fig.  |
|                                 |  | ---- | 160  | ---- |                  | $T_J = 125^\circ\text{C}$ 17   |

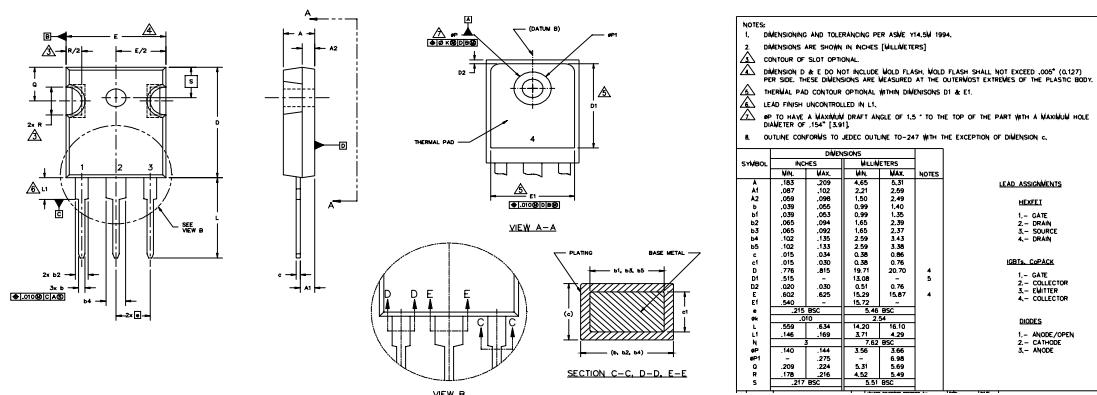
# IRG4PC50FDPbF

## Notes:

- ① Repetitive rating:  $V_{GE}=20V$ ; pulse width limited by maximum junction temperature (figure 20)
  - ②  $V_{CC}=80\% (V_{CES})$ ,  $V_{GE}=20V$ ,  $L=10\mu H$ ,  $R_G = 5.0\Omega$  (figure 19)
  - ③ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$ .
  - ④ Pulse width  $5.0\mu s$ , single shot.

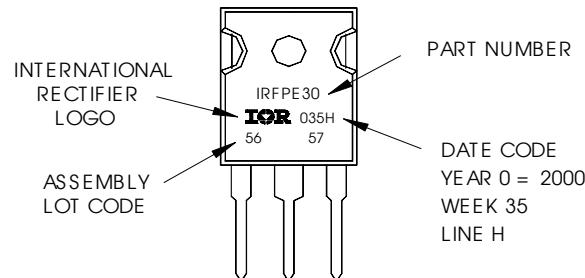
## TO-247AC Package Outline

Dimensions are shown in millimeters (inches)



## TO-247AC Part Marking Information

**EXAMPLE:** THIS IS AN IRFPE30  
WITH ASSEMBLY  
LOT CODE 5657  
ASSEMBLED ON WW 35, 2000  
IN THE ASSEMBLY LINE "H"  
**Note:** "P" in assembly line  
position indicates "Lead-Free"



Data and specifications subject to change without notice.

# International **ICR** Rectifier